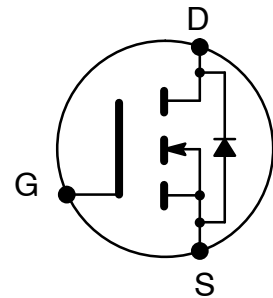




ELECTRONICS, INC.  
 44 FARRAND STREET  
 BLOOMFIELD, NJ 07003  
 (973) 748-5089  
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**NTE2939**  
**MOSFET**  
**N-Ch, Enhancement Mode**  
**High Speed Switch**  
**TO-220 Full Pack Type Package**



**Features:**

- Low Drain-Source ON Resistance:  $R_{DS(ON)} = 0.33\Omega$  Typ.
- High Forward Transfer Admittance:  $|Y_{fs}| = 6.5$  S Typ.
- Low Leakage Current:  $I_{DSS} = 10\mu A$  Max. ( $V_{DS} = 600V$ )
- Enhancement-Mode:  $V_{th} = 2.0V$  to  $4.0V$  ( $V_{DS} = 10V$ ,  $I_D = 1mA$ )

**Absolute Maximum Ratings:** ( $T_A = +25^\circ C$ , Note 1 unless otherwise specified)

Drain-Source Voltage, $V_{DSS}$ .....	600V
Gate-Source Voltage, $V_{GSS}$ .....	$\pm 30$
Drain Current (Note 2), $I_D$	
DC .....	13A
Pulsed .....	52A
Drain Power Dissipation ( $T_C = +25^\circ C$ ), $P_D$ .....	50W
Single Pulse Avalanche Energy (Note 3), $E_{AS}$ .....	511mJ
Avalanche Current, $I_{AR}$ .....	13A
Repetitive Avalanche Energy (Note 4), $E_{AR}$ .....	5mJ
Channel Temperature, $T_{ch}$ .....	$+150^\circ C$
Storage Temperature Range, $T_{stg}$ .....	$-55^\circ$ to $+150^\circ C$
Thermal Resistance, Channel-to-Case, $R_{thCH-C}$ .....	$2.5^\circ C/W$
Thermal Resistance, Channel-to-Ambient, $R_{thCH-A}$ .....	$62.5^\circ C/W$

Note 1. Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc. may cause this device to decrease in reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the Absolute Maximum Ratings. This transistor is an electrostatic sensitive device. Please handle with caution.

Note 2. Make sure that the device channel temperature is below  $+150^\circ C$ .

Note 3.  $V_{DD} = 90V$ ,  $T_{ch} = +25^\circ C$  (Initial),  $L = 5.3mH$ ,  $R_G = 25\Omega$ ,  $I_{AR} = 13A$

Note 4. Repetitive rating; pulse width limited by maximum channel temperature.



**Electrical Characteristics:** ( $T_A = +25^\circ\text{C}$  unless otherwise specified)

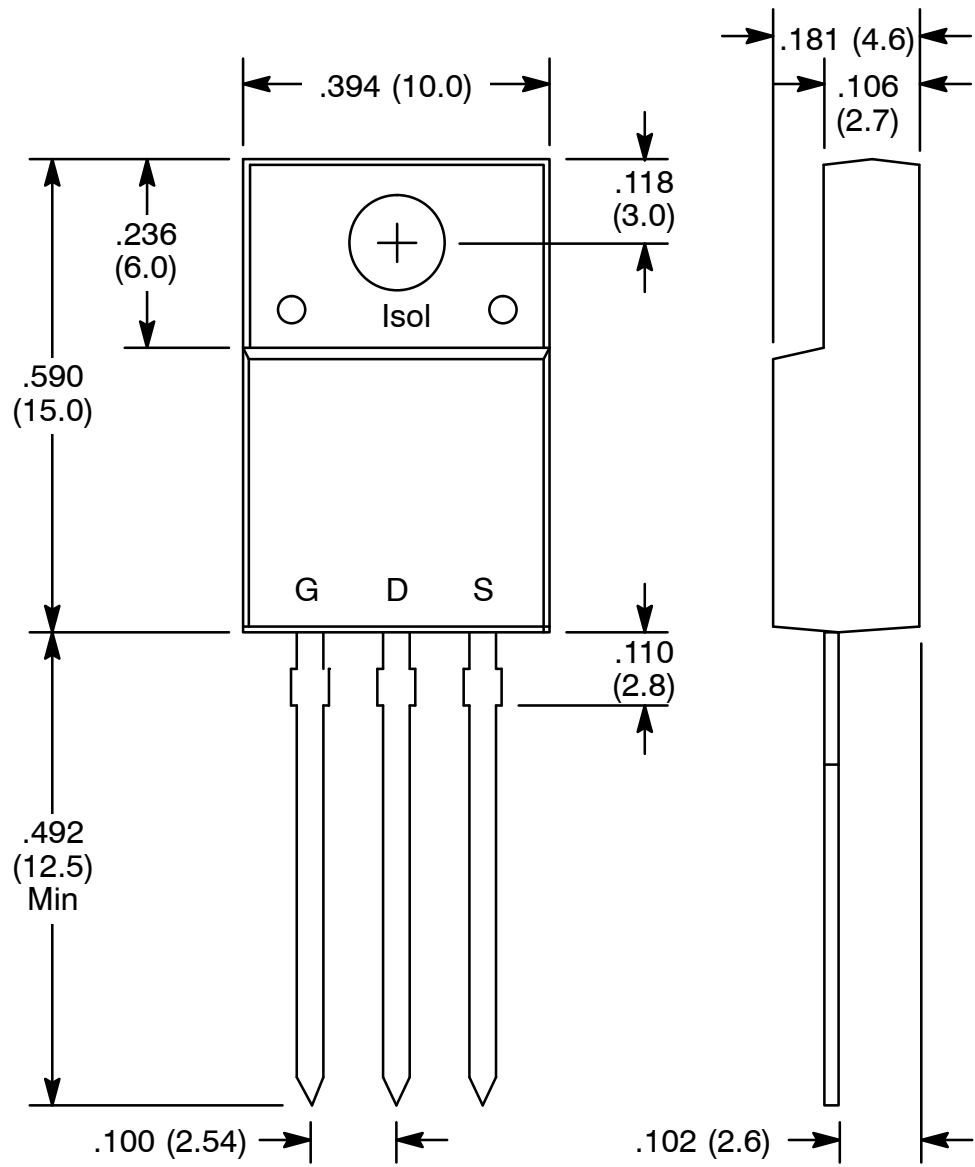
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Gate Leakage Current	$I_{GSS}$	$V_{GS} = \pm 30\text{V}, V_{DS} = 0\text{V}$	–	–	$\pm 1$	$\mu\text{A}$
Drain Cut-Off Current	$I_{DSS}$	$V_{DS} = 600\text{V}, V_{GS} = 0\text{V}$	–	–	10	$\mu\text{A}$
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{V}, I_D = 10\text{mA}$	600	–	–	V
Gate Threshold Voltage	$V_{th}$	$V_{DS} = 10\text{V}, I_D = 1\text{mA}$	2.0	–	4.0	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 10\text{V}, I_D = 6.5\text{A}$	–	0.33	0.43	$\Omega$
Forward Transfer Admittance	$ Y_{fs} $	$V_{DS} = 10\text{V}, I_D = 6.5\text{A}$	1.8	6.5	–	S
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = 1\text{MHz}$	–	2300	–	pF
Output Capacitance	$C_{oss}$		–	250	–	pF
Reverse Transfer Capacitance	$C_{rss}$		–	10	–	pF
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 200\text{V}, I_D = 6.5\text{A}, R_L = 30\Omega,$ Note 5	–	100	–	ns
Rise Time	$t_r$		–	50	–	ns
Turn-Off Delay Time	$t_{d(off)}$		–	140	–	ns
Fall Time	$t_f$		–	25	–	ns
Total Gate Charge	$Q_g$	$I_D = 13\text{A}, V_{DS} = 400\text{V}, V_{GS} = 10\text{V}$	–	40	–	nC
Gate-to-Source Charge	$Q_{gs}$		–	25	–	nC
Gate-to-Drain (“Miller”) Charge	$Q_{gd}$		–	15	–	nC

Note 5. Duty Cycle  $\leq 1\%$ ,  $t_w = 10\mu\text{s}$ .

**Source-Drain Ratings and Characteristics:** ( $T_A = +25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Continuous Drain Reverse Current	$I_{DR}$	Note 2	–	–	13	A
Pulsed Drain Reverse Current	$I_{DRP}$	Note 2	–	–	52	A
Diode Forward Voltage	$V_{DSF}$	$I_{DR} = 13\text{A}, V_{GS} = 0\text{V}$	–	–	–1.7	V
Reverse Recovery Time	$t_{rr}$	$I_{DR} = 13\text{A}, V_{GS} = 0\text{V},$ $di_{DR}/dt = 100\text{A}/\mu\text{s}$	–	1600	–	ns
Reverse Recovery Charge	$Q_{rr}$		–	20	–	$\mu\text{C}$

Note 2. Make sure that the device channel temperature is below  $+150^\circ\text{C}$ .



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